



TE Internal #: 8-55862-5
 Ring Terminals & Spade Terminals, Ring Tongue, 8 AWG Wire Size,
 6.64 – 10.54 mm² Wire Size, 13100 – 20800 CMA Wire Size, Stud
 Size #10

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Terminals & Splices > Ring Terminals & Spade Terminals



Ring & Spade Terminal Type: **Ring Tongue**

Wire Size: **13100 – 20800 CMA**

Stud Size: **#10**

Features

Product Type Features

Terminal Features	Heavy Duty
Stud Size	#10
Sealable	Yes
Wire Insulation Support Retention Type	Insulation Support

Configuration Features

Number of Holes	1
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Electrical Characteristics

Voltage Rating	1000 V, 600 V
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Contact Features

Ring & Spade Terminal Type	Ring Tongue
Barrel Type	Closed
Terminal Orientation	Straight
Terminal Plating Material	Tin

Mechanical Attachment

Wire Insulation Support	With
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Dimensions

Wire Size	13100 – 20800 CMA
Stud Diameter	4.82 mm[.189 in][.19 in]
Tongue Thickness	1.19 mm[.047 in]
Product Length	44.2 mm[1.737 in]



Compatible Insulation Diameter (Max)	7.87 mm[.31 in]
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Compatible Insulation Diameter Range	7.87 mm[.31 in]
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Usage Conditions

Insulation Option	Partially Insulated
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Operating Temperature Range	125 °C[257 °F]
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Operation/Application

Compatible With Wire Base Material	Copper
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Compatible With Wire Plating Material	Tin
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Industry Standards

Government Qualified Terminal	No
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Packaging Features

Packaging Quantity	10
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Packaging Method	Loose Piece
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Product Compliance

[For compliance documentation, visit the product page on TE.com>](#)

EU RoHS Directive 2011/65/EU	Compliant
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EU ELV Directive 2000/53/EC	Compliant
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China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
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EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUL 2021 (219) Does not contain REACH SVHC
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Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
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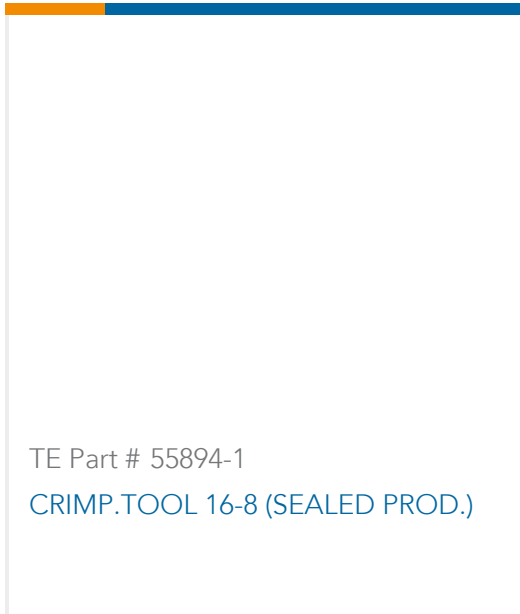
Solder Process Capability	Not applicable for solder process capability
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Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on

requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

Compatible Parts



Customers Also Bought



Documents

Product Drawings

#8 PRE-INSUL SEALED TERM R

English

Instruction Sheets

Instruction Sheet (U.S.)

English